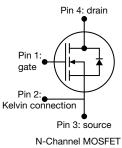
Vishay Siliconix



E Series Power MOSFET





PRODUCT SUMMARY				
V_{DS} (V) at T_J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.120		
Q _g max. (nC)	44			
Q _{gs} (nC)	11			
Q _{gd} (nC)	8			
Configuration	Single			

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION					
Package	PowerPAK 8 x 8				
Lead (Pb)-free and halogen-free	SiHH120N60E-T1-GE3				

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-source voltage	V _{DS}	600	V			
Gate-source voltage	V _{GS}	± 30	V			
Continuous drain current (T _J = 150 °C)	V_{GS} at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$	- I _D	24	A		
	V_{GS} at 10 V $T_C = 100 \text{ °C}$		15			
Pulsed drain current ^a	I _{DM}	57	1			
Linear derating factor		1.25	W/°C			
Single pulse avalanche energy ^b	E _{AS}	56	mJ			
Maximum power dissipation	PD	156	W			
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope	T _J = 125 °C	dv/dt	100	V/ns		
Reverse diode dv/dt ^c	uv/dl	50	v/ns			

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2 A
- c. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

1



COMPLIANT

HALOGEN

FREE



PARAMETER	SYMBOL	TYP.	MAX.	MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	42	42 55			°041/		
Maximum junction-to-case (drain)	R _{thJC}	0.57		°C/W				
SPECIFICATIONS (T _J = 25 °C, ur	nless otherwis	se noted)						
PARAMETER	SYMBOL	1	T CONDITIONS	MIN.	TYP.	MAX.	UNI	
Static	I				I	<u></u>		
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.60	-	V/°(
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μA	3.0	-	5.0	V	
Cata agurra lagkara			$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 30 V	-	-	± 1	μA	
		V _{DS} =	= 600 V, V _{GS} = 0 V	-	-	1		
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	′, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 12 A	-	0.106	0.120	Ω	
Forward transconductance	9 _{fs}	V _{DS}	= 20 V, I _D = 12 A	-	6.9	-	S	
Dynamic		•			•	•		
Input capacitance	C _{iss}		V _{GS} = 0 V, V _{DS} = 100 V,		1600	-		
Output capacitance	C _{oss}				76	-		
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	6	-		
Effective output capacitance, energy related ^a	C _{o(er)}			-	57	-	pł	
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{\rm DS} = 0$	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		355	-	1	
Total gate charge	Qg			-	29	44		
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 12 \text{ A}, V_{DS} = 480 \text{ V}$	-	11	-	nC	
Gate-drain charge	Q _{gd}			-	8	-		
Turn-on delay time	t _{d(on)}			-	25	50		
Rise time	tr	V _{DD} =	= 480 V, I _D = 12 A,	-	47	94	1 _	
Turn-off delay time	t _{d(off)}		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		38	78	n	
Fall time	t _f				29	58	1	
Gate input resistance	R _g	f = 1 MHz		0.32	0.63	1.26	Ω	
Drain-Source Body Diode Characteristic	, , , , , , , , , , , , , , , , , , ,							
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	24		
Pulsed diode forward current	I _{SM}			-	-	57	A	
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 12 A, V _{GS} = 0 V	-	-	1.2	V	
Reverse recovery time	t _{rr}			-	343	686	n	
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 12 \text{ A},$ di/dt = 100 A/µs, V _R = 400 V		-	5.6	11.2	μ	
Reverse recovery current	I _{RRM}			-	30	_	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDS



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

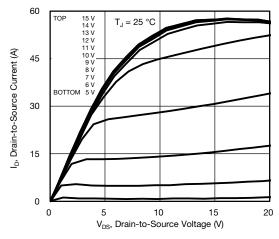
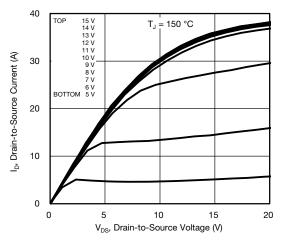


Fig. 1 - Typical Output Characteristics





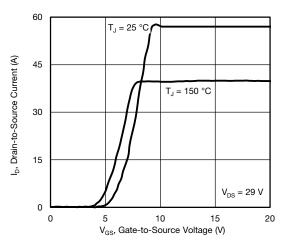


Fig. 3 - Typical Transfer Characteristics

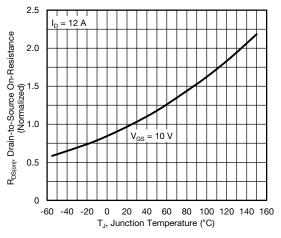


Fig. 4 - Normalized On-Resistance vs. Temperature

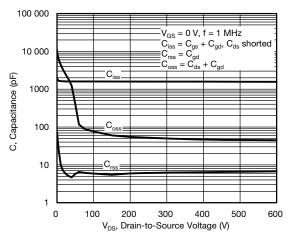


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

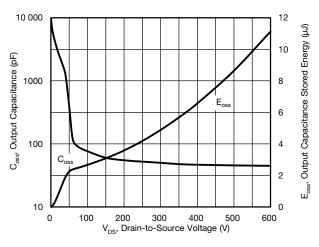


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

S20-0341-Rev. B, 11-May-2020

3 questions contact: hym@vis

Document Number: 92093

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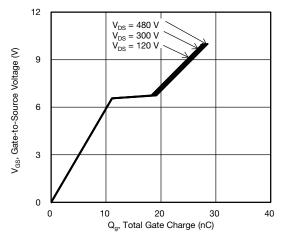


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

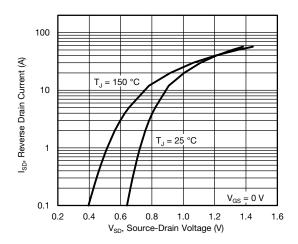


Fig. 8 - Typical Source-Drain Diode Forward Voltage

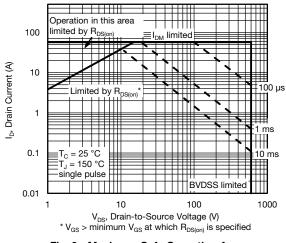


Fig. 9 - Maximum Safe Operating Area

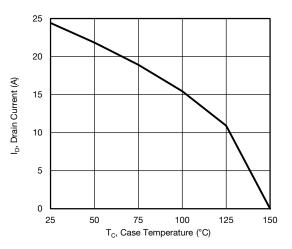


Fig. 10 - Maximum Drain Current vs. Case Temperature

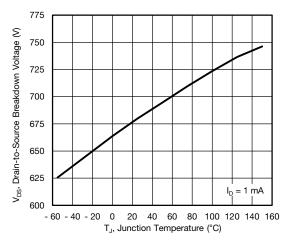


Fig. 11 - Temperature vs. Drain-to-Source Voltage

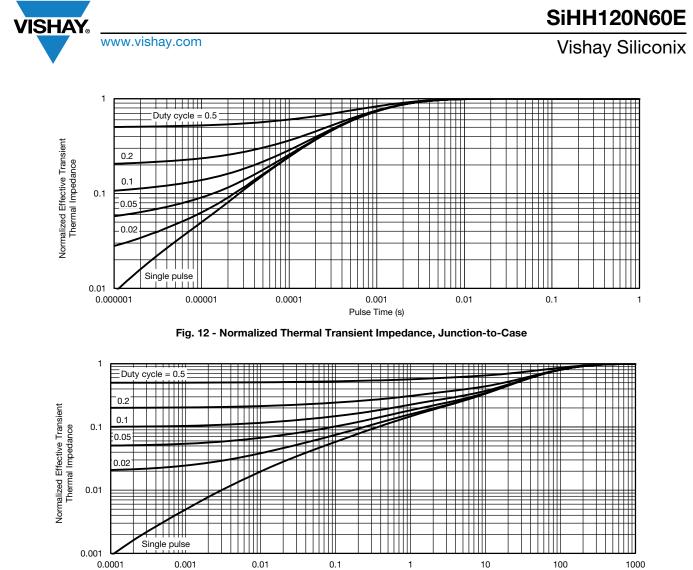


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

Pulse Time (s)

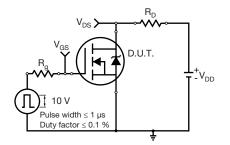


Fig. 14 - Switching Time Test Circuit

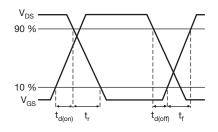


Fig. 15 - Switching Time Waveforms



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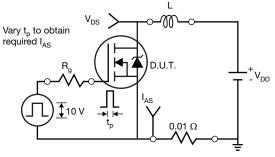


Fig. 16 - Unclamped Inductive Test Circuit

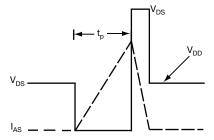


Fig. 17 - Unclamped Inductive Waveforms

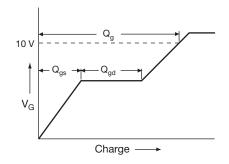


Fig. 18 - Basic Gate Charge Waveform

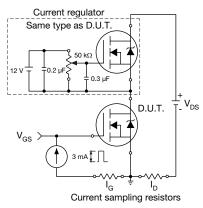


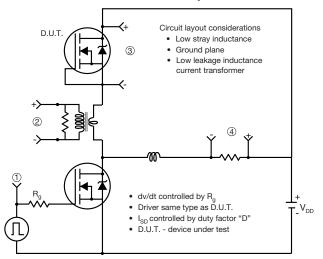
Fig. 19 - Gate Charge Test Circuit

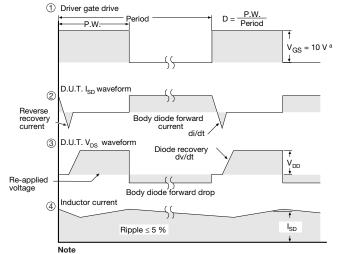
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Peak Diode Recovery dv/dt Test Circuit





a. $V_{GS} = 5 V$ for logic level devices

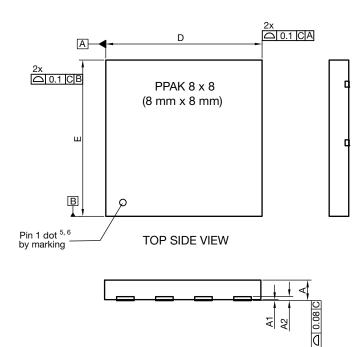
Fig. 20 - For N-Channel

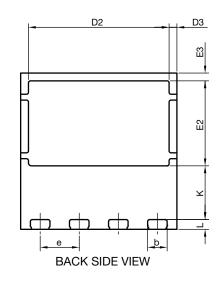
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?92093.

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PowerPAK[®] 8 x 8 Case Outline





DIM		MILLIMETERS			INCHES	
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	0.95	1.00	1.05	0.037	0.039	0.041
A1	0.00	-	0.05	0.000	-	0.002
A2	020 ref.		0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041
D	7.90	8.00	8.10	0.311	0.315	0.319
D2	7.10	7.20	7.30	0.280	0.283	0.287
D3	0.40 BSC		0.016 BSC			
е	2.00 BSC		0.079 BSC			
E	7.90	8.00	8.10	0.311	0.315	0.319
E2	4.30	4.35	4.40	0.169	0.171	0.173
E3	0.40 BSC		0.016 BSC			
К	2.75 BSC		0.108 BSC			
L	0.45	0.50	0.55	0.018	0.020	0.022
N ⁽³⁾	8 8					

Notes

⁽¹⁾ Use millimeters as the primary measurement

⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5 M - 1994

⁽³⁾ N is the number of terminals

⁽⁴⁾ The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

⁽⁵⁾ Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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